# Innogration (Suzhou) Co., Ltd.

## 500-4200MHz, 8W, 28V RF Power LDMOS FETs

## **Description**

The ITCH42008E2 is a 8-watt, internally matched LDMOS FET, designed for cellular base station and ISM applications with frequencies from 500MHz to 4200 MHz

• Typical Performance (On Innogration fixture with device soldered):  $V_{DD} = 28 \text{ Volts}, I_{DQ} = 100 \text{ mA}, \text{ Pulse Width =10us, Duty Cycle =12\%.}$  3600-3800M demo:

Frequency (MHz)	Gain (dB)	P_3dB (dBm)	η <sub>D</sub> (%)
3600	13.9	41.7	47.6
3700	15.3	41.2	46.8
3800	14.2	40.9	44.9

#### 4000~4200M demo:

Frequency (MHz)	Gain (dB)	P_3dB (dBm)	η <sub>D</sub> (%)
4000	15.6	40.6	39.8
4100	14.8	40.8	41
4200	15.3	40.2	41.7

Highlight: The fixture is used same board different BOM.

# ITCH42008E2

## **Features**

- High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- · Internally Matched for Ease of Use
- Excellent thermal stability, low HCI drift

- Large Positive and Negative Gate/Source Voltage Range for Improved Class C Operation
- Pb-free, RoHS-compliant

### **Table 1. Maximum Ratings**

Rating	Symbol	Value	Unit
DrainSource Voltage	$V_{\scriptscriptstyle DSS}$	+65	Vdc
GateSource Voltage	V <sub>GS</sub>	-10 to +10	Vdc
Operating Voltage	$V_{DD}$	+32	Vdc
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	T <sub>c</sub>	+150	°C
Operating Junction Temperature	T	+225	°C

#### **Table 2. Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case	Do 10	2.6	0000
T <sub>C</sub> =85°C, T <sub>J</sub> =200°C,DC test	Rejc	3.6	°C/W

## **Table 3. ESD Protection Characteristics**

Test Methodology	Class
Human Body Model (per JESD22A114)	Class 2

Table 4. Electrical Characteristics (TA = 25°C unless otherwise noted)



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#### **DC Characteristics**

Characteristic	Conditions	Symbol	Min	Тур	Max	Unit
Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V; I <sub>DS</sub> =100uA	V <sub>DSS</sub>	65			V
Zero Gate Voltage Drain Leakage	$V_{DS} = 28 \text{ V}, V_{GS} = 0 \text{ V}$				4	
Current		I <sub>DSS</sub>			1	μΑ
GateSource Leakage Current	V <sub>GS</sub> = 9 V, V <sub>DS</sub> = 0 V	I <sub>GSS</sub>			1	μΑ
Gate Threshold Voltage	$V_{DS} = 28V, I_{D} = 300 \mu A$	V <sub>GS</sub> (th)		1.75		V
Gate Quiescent Voltage	$V_{DS} = 28 \text{ V}, I_{DS} = 150 \text{ mA},$	1/		0.7		V
	Measured in Functional Test	$V_{GS(Q)}$		2.7		V

Pulse CW Signal performance (In Innogration Test Fixture, 50 ohm system):  $V_{DD} = 28 \text{ Vdc}$ ,  $I_{DQ} = 100 \text{ mA}$ , f = 4200 MHz, Pulse CW, Pulse Width =10us, Duty Cycle =12%.

Characteristic	Symbol	Min	Тур	Max	Unit
Power Gain	Gp		15.3		dB
Drain Efficiency@P3dB	$\eta_{\scriptscriptstyle D}$		41.7		%
3dB Compression Point	P <sub>-3dB</sub>		40.2		dBm
Input Return Loss	IRL		-7		dB

Load Mismatch (In Innogration Test Fixture, 50 ohm system):  $V_{DD} = 28 \text{ Vdc}, I_{DQ} = 100 \text{ mA}, f = 4200 \text{ MHz}$ 

VSWR 10:1 at 10W Pulsed CW Output Power	No Device Degradation
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## **TYPICAL CHARACTERISTICS**

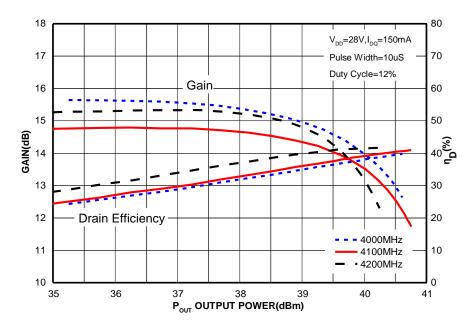


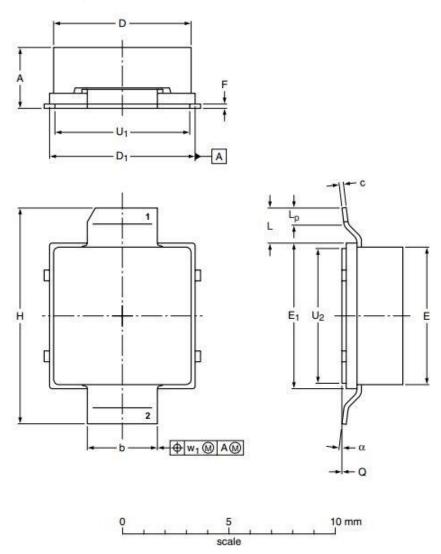
Figure 1. Power gain and drain efficiency as function of Pulse output power



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## **Package Outline**

## Earless Flanged ceramic package; 2 leads



UNIT	Α	b	С	D	D <sub>1</sub>	E	E <sub>1</sub>	F	н	L	$L_P$	Q	Uı	U <sub>2</sub>	W <sub>1</sub>	α
	3.63	3.38	0.23	6.55	6.93	6.55	6.93	0.23	10.29	1.65	1.02	+0.05	6.43	6.43	0.51	7°
mm	3.05	3.23	0.18	6.40	6.78	6.40	6.78	0.18	10.03	1.00	0.51	-0.05	6.27	6.27	0.51	0°
inches	0.143	0.133	0.009	0.258	0.273	0.258	0.273	0.009	0.405	0.065	0.040	+0.002	0.253	0.253	0.02	7°
inches	0.120	0.127	0.007	0.252	0.267	0.252	0.267	0.007	0.395	0.065	0.020	-0.002	0.247	0.247	0.02	0°

OUTLINE		REFE	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	IOOOL DATE
PKG-E-A						10/22/2013

Document Number: ITCH42008E2 Preliminary Datasheet V2.0

## **Revision history**

Table 5. Document revision history

Date	Revision	Datasheet Status
2017/02/23	Rev 1.0	Preliminary Datasheet
2017/7/12	Rev 2.0	Frequency range updated

## **Disclaimers**

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